JJMICROELECTRONICS

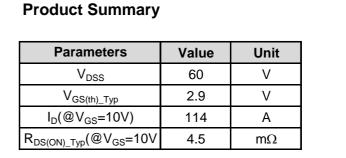
60V, 114A, 4.5mΩ N-channel Power SGT MOSFET JMSH0606PG

Features

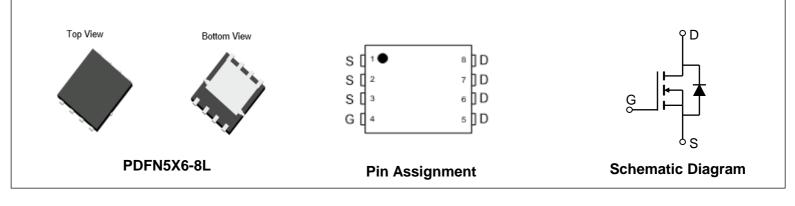
- Excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$ and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

Applications

- Load Switch
- PWM Application
- Power Management







Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMSH0606PG-13	SH0606P	1	Tape&Reel	PDFN5x6-8L	5000	50000

Absolute Maximum Ratings (@ T_c = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit	
V _{DS}	Drain-to-Source Voltage	Drain-to-Source Voltage		V	
V _{GS}	Gate-to-Source Voltage		±20	V	
I _D	Continuous Drain Current	$T_C = 25^{\circ}C$	114	Α	
		$T_{\rm C} = 100^{\circ}{\rm C}$	72	A	
I _{DM}	Pulsed Drain Current ⁽¹⁾	Pulsed Drain Current ⁽¹⁾		А	
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		188	mJ	
P _D	Power Dissipation	$T_C = 25^{\circ}C$	104	W	
		$T_{\rm C} = 100^{\circ}{\rm C}$	42	vv	
T _J , T _{STG}	Junction & Storage Temperature R	lange	-55 to 150	°C	

Thermal Characteristics

Symbol	Parameter	Мах	Unit	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient ⁽³⁾	43	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2		

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	iracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0V$	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics			-	-	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	2.9	3.7	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 20A$	-	4.5	5.8	mΩ
Dynami	c Characteristics					
R_g	Gate Resistance	f = 1MHz	-	2.2	-	Ω
C _{iss}	Input Capacitance		1264	1770	2389	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz	648	907	1225	pF
C_{rss}	Reverse Transfer Capacitance		35	49	66	pF
Q_g	Total Gate Charge		21	29	39	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_D = 20A$	-	8	11	nC
Q_{gd}	Gate Drain("Miller") Charge	VDS = 0000, 10 = 2070	-	8	11	nC
Switchi	ng Characteristics					
t _{d(on)}	Turn-On DelayTime		-	11	-	ns
tr	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 30V	-	25	-	ns
t _{d(off)}	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 3 Ω	-	25	-	ns
t _f	Turn-Off Fall Time	1	-	10	-	ns
Body D	iode Characteristics			•	4	
I _S	Maximum Continuous Body Diode Forward Current		-	-	114	А
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	456	А
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time		30	42	56	ns
Qrr	Body Diode Reverse Recovery Charge	− I _F = 20A, di/dt = 100A/us	-	40	-	nC

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

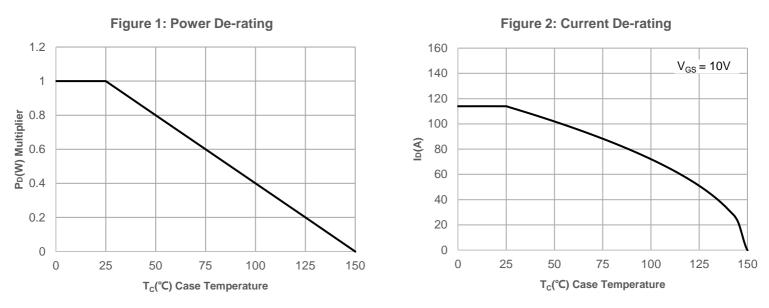
2. E_{AS} condition: Starting T_J =25C, V_{DD} =30V, V_{GS} =10V, R_G =25ohm, L=3mH, I_{AS} =11.2A, V_{DD} =0V during time in avalanche.

3. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width ${\leqslant}300\mu\text{s},$ Duty Cycle ${\leqslant}0.5\%.$







Typical Performance Characteristics



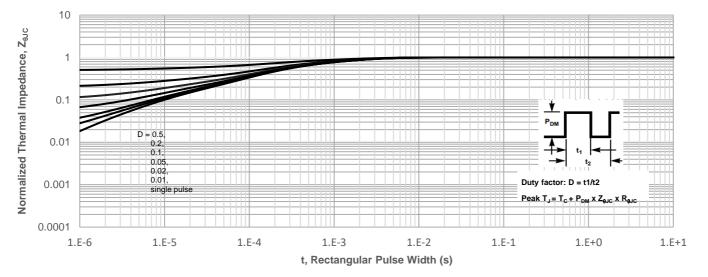
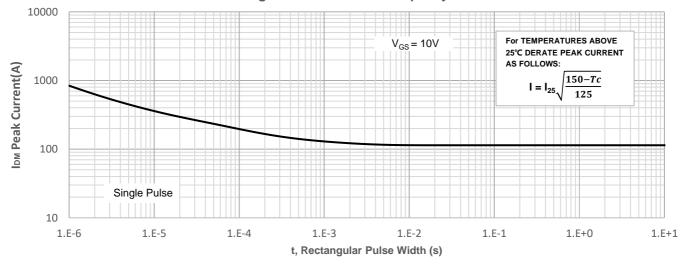
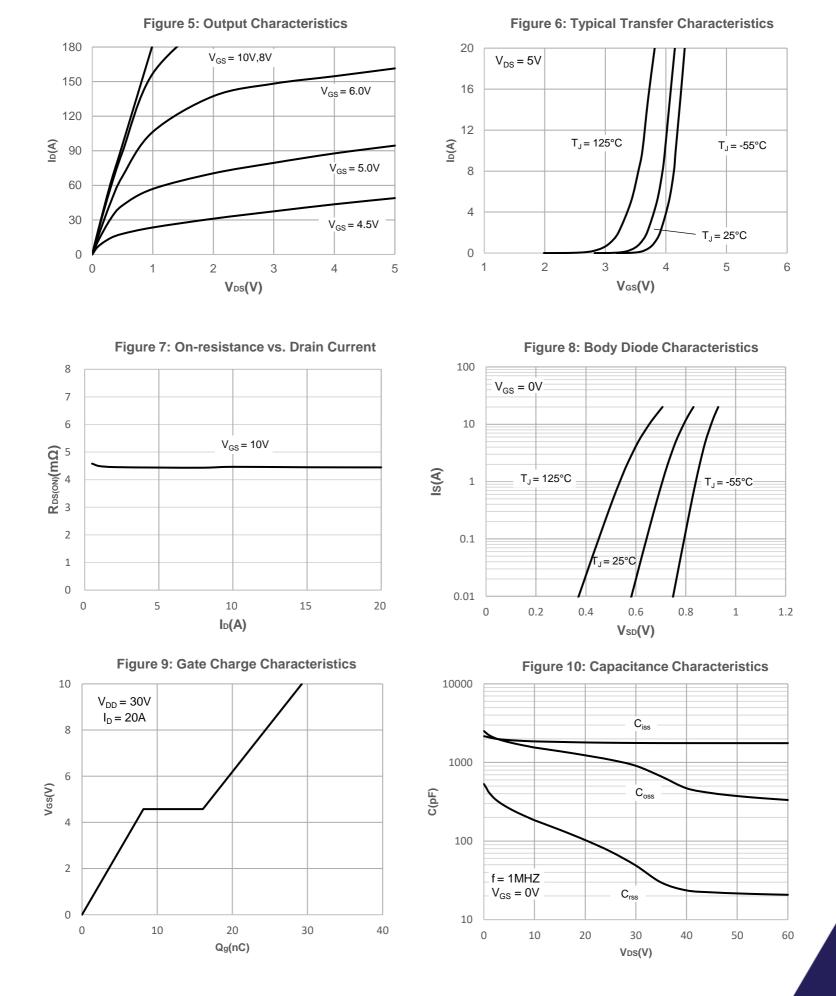


Figure 4: Peak Current Capacity





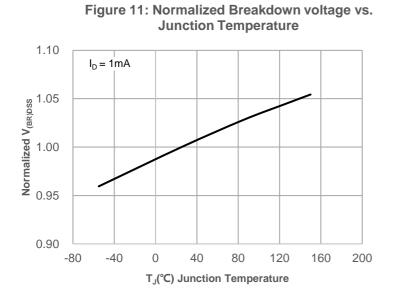


Typical Performance Characteristics

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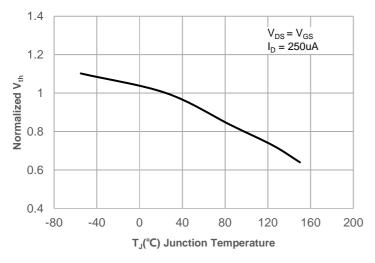
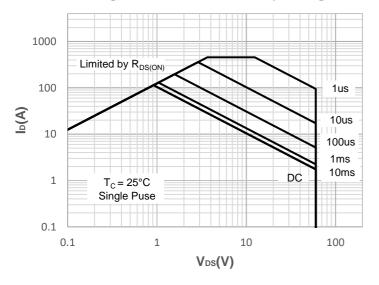
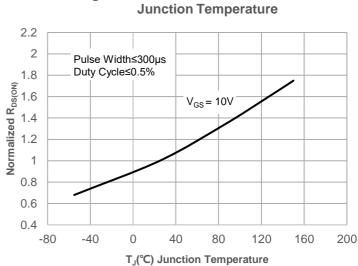


Figure 15: Maximum Safe Operating Area





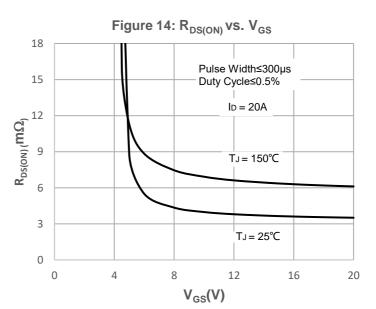


Figure 12: Normalized on Resistance vs. **Junction Temperature**



Test Circuit

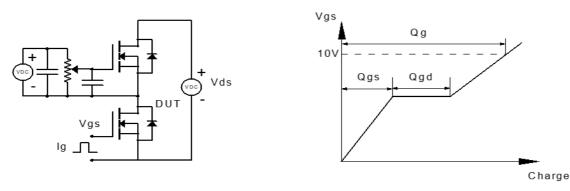


Figure 1: Gate Charge Test Circuit & Waveform

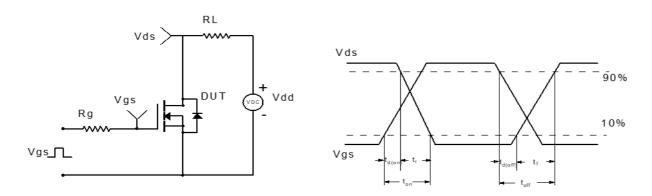


Figure 2: Resistive Switching Test Circuit & Waveform

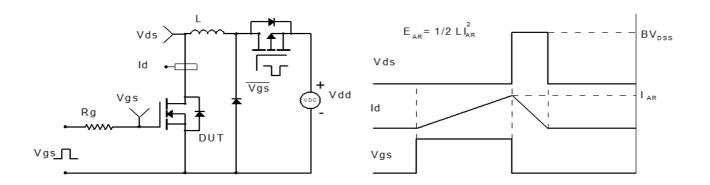


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

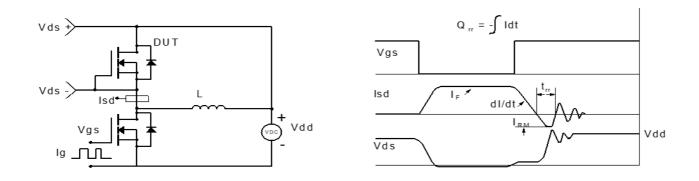
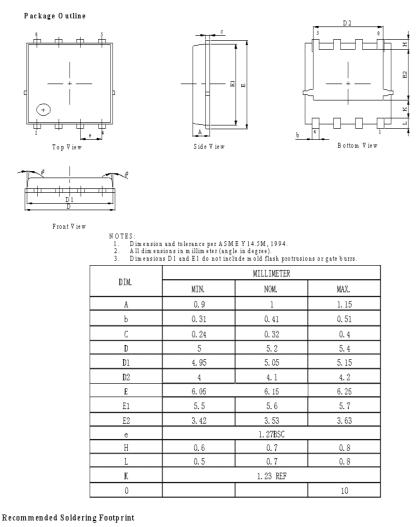
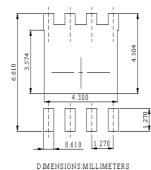


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(PDFN5X6-8L)





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